IN THE CLAIMS

Please amend the claims to the following:

1. (Currently Amended) A method comprising:

dispersing zeolite particles in a liquid sol to form a zeolite - sol colloid;

depositing the zeolite - sol colloid on an underlying layer; and

extracting a first amount of the liquid from the zeolite - sol colloid to form a wet gel -

zeolite composite film, wherein a second amount of the liquid remains in the wet-gel zeolite composite film;

opening a via and a trench in the wet gel - zeolite composite film;

forming a conductive material in the via and the trench of the wet gel - zeolite composite

film; and

depositing an interlayer dielectric (ILD) on the wet gel - zeolite composite film; and forming the wet gel - zeolite composite film into an aerogel - zeolite composite film, after forming the conductive material and depositing the ILD.

2. (Cancelled)

- (Previously Amended) The method of claim 1, wherein extracting a first amount of the liquid comprises: drying the zeolite – sol colloid.
- (Original) The method of claim 3, wherein drying the zeolite sol colloid comprises: oxidizing the zeolite – sol colloid.

- (Previously Amended) The method of claim 1, wherein extracting a first amount of the liquid comprises: vacuuming the liquid out of the zeolite – sol colloid.
- (Previously Amended) The method of claim 1, wherein extracting a first amount of the liquid comprises: heating the zeolite – sol colloid.
- (Original) The method of claim 6, wherein the zeolite sol colloid is heated under a
 vacuum.
- (Original) The method of claim 1, further comprising: calcinating the wet gel zeolite composite.
- (Original) The method of claim 8, wherein calcinating the wet gel zeolite composite
 comprises: heating the wet gel zeolite composite; and cooling the wet gel zeolite
 composite.
- (Original) The method of claim 9, wherein the wet gel zeolite composite is heated under a vacuum.
- 11. (Original) The method of claim 8, wherein calcinating the wet gel zeolite composite to form a composite gel-zeolite dielectric layer comprises: oxidizing the wet gel – zeolite composite.

- 12. (Cancelled).
- 13. (Currently Amended) The method of claim 1 [[12]], wherein forming the wet gel zeolite composite film into an aerogel zeolite composite comprises extracting approximately all of the remaining liquid from the wet gel zeolite composite.
- 14. (Previously Amended) The method of claim 13, wherein the ILD comprises a second wet-gel zeolite composite film, and wherein the second wet-gel zeolite composite film is also formed into an aerogel-zeolite composite film, after forming the conductive material and depositing the ILD.
- 15. (Original) The method of claim 1, wherein dispersing the zeolite particles in the liquid sol comprises:

stirring a first amount of zeolite into the liquid sol.

- 16. (Previously Amended) The method of claim 15, wherein the first amount of zeolite is a molar percentage of the zeolite sol colloid, the molar percentage of zeolite being in the range of one to fifty percent.
- 17. (Cancelled)
- 18. (Original) The method of claim 1, wherein the sol is a silica sol.
- 19. (Original) The method of claim 1, wherein the sol comprises an alcohol.

- 20. (Original) The method of claim 19, wherein the alcohol is selected from the group consisting of ethanol, methanol, 1- or 2-propanol, or 1-butanol.
- 21. (Original) The method of claim 19, wherein the sol further comprises an acid.
- 22. (Original) The method of claim 21, wherein the acid is selected from a group consisting of hydrochloric (HCI), nitric, sulfuric, phosphoric, hydrofluoric (HF), acetic, or citric acid.
- 23. (Original) The method of claim 21, wherein the sol further comprises a silicon precursor.

- 24. (Previously Amended) The method of claim 23, wherein the silicon precursor is selected from a group consisting of tetraethoxysilane (TEOS), tetramethoxysilane-(TMOS), tetrapropozysilane (TPOS), and tetrabutoxysilane (TBOS).
- 25. (Cancelled)
- 26. (Previously Amended) The method of claim 24, wherein the acid is selected from a group consisting of hydrochloric (HCl), nitric, sulfuric, phosphoric, hydrofluoric (HF), acetic, or citric acid.
- 27. (Original) The method of claim 1, wherein depositing the zeolite sol colloid comprises: spin-coating the zeolite – sol colloid on the underlying layer.
- 28. (Original) The method of claim 1, wherein depositing the zeolite sol colloid comprises: dip-coating the zeolite – sol colloid on the underlying layer.
- 29. (Withdrawn) A method of forming a layer in an interconnect structure comprising: mixing a solution with at least a silicon precursor, a alcohol base, zeolite and water; depositing the solution on an underlying layer; gelling the solution into a wet gel; and calcinating the wet gel.
- 30. (Withdrawn) The method of claim 29, wherein depositing the solution comprises dipcoating the underlying layer in the solution.

- 31. (Withdrawn) The method of claim 29, wherein depositing the solution comprises spincoating the solution onto the underlying layer.
- 32. (Withdrawn) The method of claim 29, wherein gelling the solution into a wet gel comprises extracting at least some of the solution.
- 33. (Withdrawn) The method of claim 32, wherein extracting at least some of the solution comprises oxidizing the solution.
- 34. (Withdrawn) The method of claim 32, wherein extracting at least some of the solution comprises heating the solution.
- 35. (Withdrawn) The method of claim 29, wherein calcinating the wet gel comprises: heating the wet gel; and cooling the wet gel.
- 36. (Withdrawn) A method comprising:

forming an etch stop on an underlying layer;

spin-coating a liquid sol - zeolite colloid on the underlying layer;

extracting approximately all of the liquid from the liquid sol – zeolite colloid to form an aerogel – zeolite composite film;

etching at least a via and a trench in the aerogel – zeolite composite film; and forming a conductive material in at least the via and the trench.

- 37. (Withdrawn) The method of claim 36, wherein extracting approximately all of the liquid from the liquid sol zeolite colloid comprises: oxidizing the sol zeolite colloid.
- 38. (Withdrawn) The method of claim 36, wherein extracting approximately all of the liquid from the liquid sol – zeolite colloid comprises; heating the sol – zeolite colloid.
- 39. (Withdrawn) The method of claim 36, wherein the liquid sol is a silica based sol.
- 40. (Withdrawn) An interconnect structure comprising:
- at least one via opening and one trench defined by a gel zeolite composite dielectric, which is disposed above an underlying layer;
 - a barrier layer disposed on the surfaces of the gel-zeolite composite dielectric; and a conductive layer disposed on the barrier layer.
- (Withdrawn) The interconnect structure of claim 40, wherein the gel-zeolite composite dielectric is a wet gel - zeolite composite dielectric.
- 42. (Withdrawn) The interconnect structure of claim 40, wherein the gel-zeolite composite dielectric is an aerogel - zeolite composite dielectric.
- (Withdrawn) The interconnect structure of claim 40, wherein the gel-zeolite composite dielectric is a calcinated gel – zeolite composite dielectric.

- 44. (Withdrawn) The interconnect structure of claim 40, wherein the etch-stop is comprised of silicon nitride.
- 45. (Withdrawn) The interconnect structure of claim 40, wherein the barrier layer is comprised of tantalum.
- 46. (Withdrawn) The interconnect structure of claim 40, wherein the conductive layer is comprised of copper.